**Product data sheet** 

# 1. General description

Planar passivated very sensitive gate Silicon Controlled Rectifier in a TO92 plastic package.

### 2. Features and benefits

- Planar passivated for voltage ruggedness and reliability
- · Very sensitive gate

## 3. Applications

- Ignition circuits
- Low power latching circuits
- Protection / shut-down circuits: lighting ballasts
- Protection / shut-down circuits: Switched Mode Power Supplies

### 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Absolute	maximum rating		·			
$V_{RRM}$	repetitive peak reverse voltage		-	-	600	V
I <sub>T(AV)</sub>	average on-state current	half sine wave; T <sub>lead</sub> ≤ 83 °C; <u>Fig. 1</u>	-	-	0.5	А
$I_{T(RMS)}$	RMS on-state current	half sine wave; T <sub>lead</sub> ≤ 83 °C; <u>Fig. 2;</u> <u>Fig. 3</u>	-	-	0.8	А
	non-repetitive peak on- state current	half sine wave; $T_{j(init)} = 25  ^{\circ}C$ ; $t_p = 10  \text{ms}$ ; Fig. 4; Fig. 5	-	-	8	А
		half sine wave; T <sub>j(init)</sub> = 25 °C; t <sub>p</sub> = 8.3 ms	-	-	9	Α
T <sub>j</sub>	junction temperature		-	-	125	°C
Static cha	aracteristics				'	
I <sub>GT</sub>	gate trigger current	$V_D = 12 \text{ V; } I_T = 10 \text{ mA; } T_j = 25 \text{ °C; } Fig. 7$	15	-	50	μA
Dynamic	characteristics					
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM}$ = 402 V; $T_j$ = 125 °C; $R_{GK}$ = 1 kΩ; ( $V_{DM}$ = 67% of $V_{DRM}$ ); exponential waveform; Fig. 12	100	-	-	V/µs

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# 5. Pinning information

#### **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	А	anode		
2	G	gate		А <del>     </del> К
3	К	cathode	TO-92 (SOT54)	G sym037

## 6. Ordering information

### **Table 3. Ordering information**

Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
BT169G-L	TO92	BT169G-L,412	Reel	2000	SOT54 wide pitch	14-Nov-2013

## 7. Marking

#### Table 4. Marking codes

Type number	Marking codes				
BT169G-L	BT169GL				

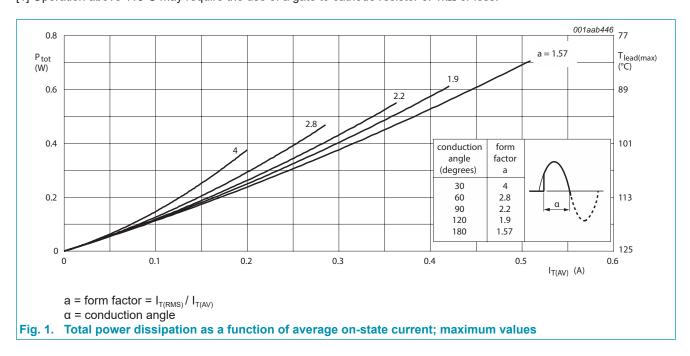
# 8. Limiting values

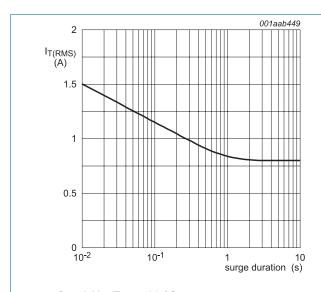
**Table 5. Limiting values** 

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_{DRM}$	repetitive peak off-state voltage			-	600	V
$V_{RRM}$	repetitive peak reverse voltage			-	600	V
I <sub>T(AV)</sub>	average on-state current	half sine wave; T <sub>lead</sub> ≤ 83 °C; <u>Fig. 1</u>		-	0.5	А
I <sub>T(RMS)</sub>	RMS on-state current	half sine wave; T <sub>lead</sub> ≤ 83 °C; <u>Fig. 2</u> ; <u>Fig. 3</u>		-	0.8	А
I <sub>TSM</sub>	non-repetitive peak on- state current	half sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 10 ms; Fig. 4; Fig. 5		-	8	A
		half sine wave; $T_{j(init)} = 25 \text{ °C}$ ; $t_p = 8.3 \text{ ms}$		-	9	А
l <sup>2</sup> t	I <sup>2</sup> t for fusing	t <sub>p</sub> = 10 ms; SIN		-	0.32	A <sup>2</sup> s
dl <sub>⊤</sub> /dt	rate of rise of on-state current	$I_T = 2 \text{ A}; I_G = 10 \text{ mA}; dI_G/dt = 100 \text{ mA/}\mu\text{s}$		-	50	A/µs
I <sub>GM</sub>	peak gate current			-	1	А
$V_{RGM}$	peak reverse gate voltage			-	5	V
$P_{GM}$	peak gate power			-	2	W
$P_{G(AV)}$	average gate power	over any 20 ms period		-	0.1	W
T <sub>stg</sub>	storage temperature			-40	150	°C
T <sub>j</sub>	junction temperature		[1]	-	125	°C

[1] Operation above 110°C may require the use of a gate to cathode resistor of  $1k\Omega$  or less.





f = 50 Hz;  $T_{lead}$  = 83 °C

Fig. 2. RMS on-state current as a function of surge duration for sinusoidal currents

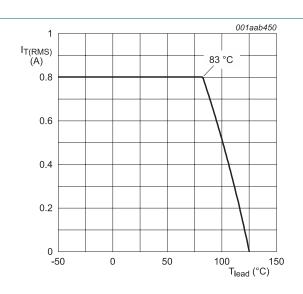
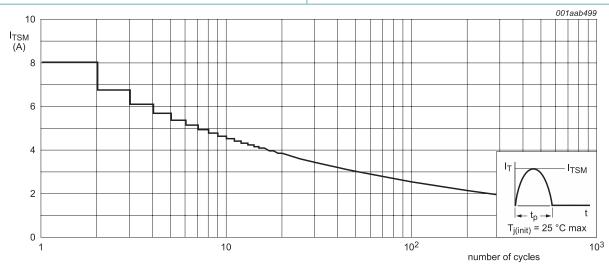


Fig. 3. RMS on-state current as a function of lead temperature; maximum values

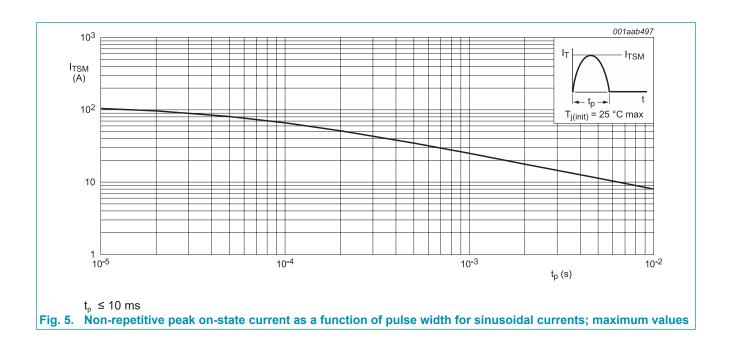


f = 50 Hz

Fig. 4. Non-repetitive peak on-state current as a function of the number of sinusoidal currents cycles; maximum values

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### 9. Thermal characteristics

**Table 6. Thermal characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-lead)}}$	thermal resistance from junction to lead	Fig. 6	-	-	60	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	printed circuit board mounted: lead length = 4 mm	-	150	-	K/W

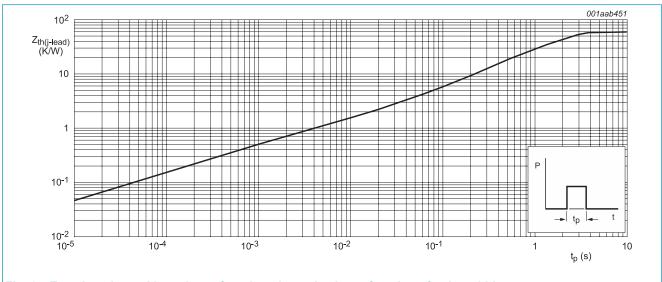


Fig. 6. Transient thermal impedance from junction to lead as a function of pulse width

## 10. Characteristics

#### **Table 7. Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
I <sub>GT</sub>	gate trigger current	$V_D = 12 \text{ V}; I_T = 10 \text{ mA}; T_j = 25 \text{ °C};$ Fig. 7	15	-	50	μA
I <sub>L</sub>	latching current	$V_D = 12 \text{ V}; I_G = 0.5 \text{ mA}; T_j = 25 \text{ °C};$ Fig. 8	-	2	4	mA
I <sub>H</sub>	holding current	V <sub>D</sub> = 12 V; T <sub>j</sub> = 25 °C; <u>Fig. 9</u>	-	0.4	1	mA
V <sub>T</sub>	on-state voltage	I <sub>T</sub> = 1.2 A; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>	-	1.25	1.7	V
$V_{\text{GT}}$	gate trigger voltage	$V_D = 12 \text{ V; } I_T = 10 \text{ mA; } T_j = 25 \text{ °C;}$ Fig. 11	-	0.5	0.8	V
		$V_D = 400 \text{ V}; I_T = 10 \text{ mA}; T_j = 125 \text{ °C}$	0.2	0.3	-	V
I <sub>D</sub>	off-state current	$V_D = 600 \text{ V}; R_{GK} = 1 \text{ k}\Omega; T_j = 25 \text{ °C}$	-	-	2	μA
		$V_D = 600 \text{ V}; R_{GK} = 1 \text{ k}\Omega; T_j = 125 \text{ °C}$	-	0.05	0.1	mA
I <sub>R</sub>	reverse current	$V_R = 600 \text{ V}; T_j = 25 \text{ °C}; R_{GK} = 1 \text{ k}\Omega$	-	-	2	μA
		$V_R = 600 \text{ V}; T_j = 125 \text{ °C}; R_{GK} = 1 \text{ k}\Omega$	-	0.05	0.1	mA
Dynamic	characteristics		,			
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM}$ = 402 V; $T_j$ = 125 °C; $R_{GK}$ = 1 kΩ; ( $V_{DM}$ = 67% of $V_{DRM}$ ); exponential waveform; Fig. 12	100	-	-	V/µs

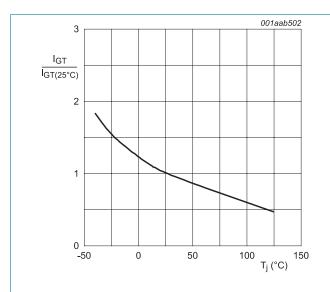
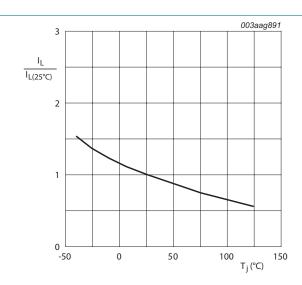
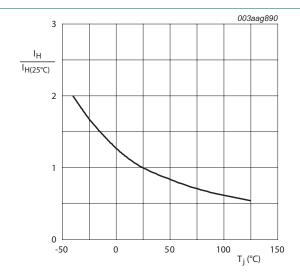


Fig. 7. Normalized gate trigger current as a function of junction temperature

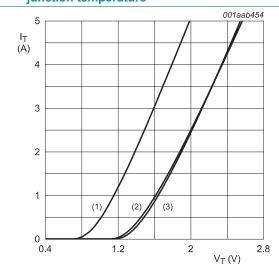


R<sub>GK</sub> = 1 kΩ

Fig. 8. Normalized latching current as a function of junction temperature



 $R_{\text{GK}} = 1 \; k\Omega$  Fig. 9. Normalized holding current as a function of junction temperature



 $V_o$  = 1.067 V;  $R_s$  = 0.187 Ω (1)  $T_j$  = 125 °C; typical values (2)  $T_j$  = 125 °C; maximum values (3)  $T_i$  = 25 °C; maximum values

Fig. 10. On-state current as a function of on-state voltage

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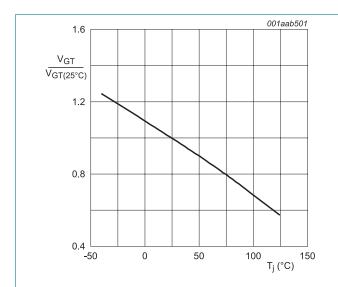
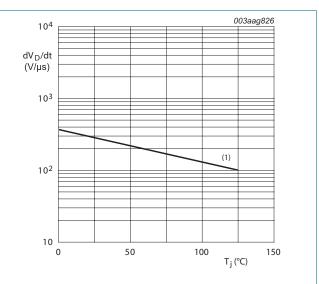
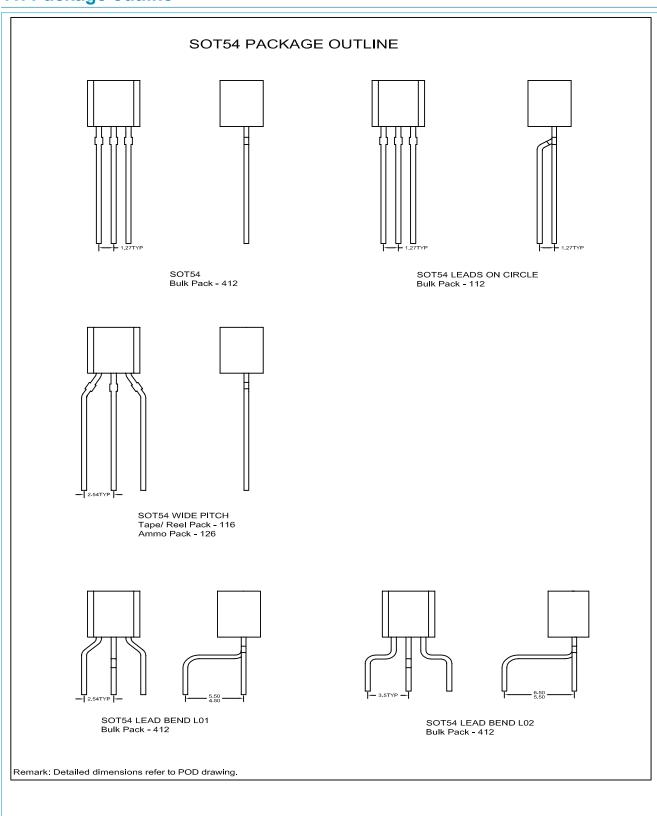


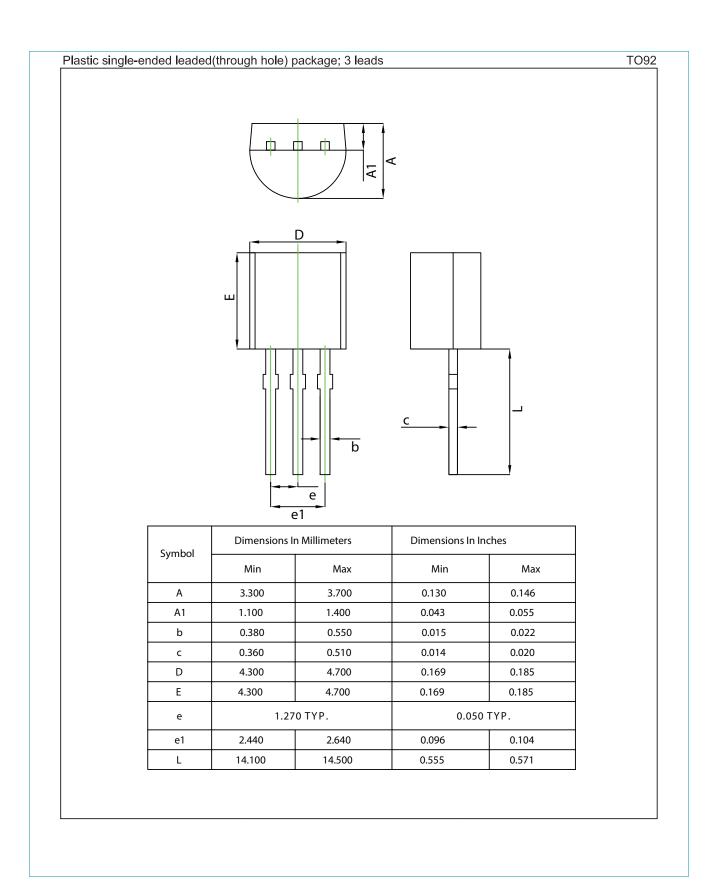
Fig. 11. Normalized gate trigger voltage as a function of junction temperature



(1)  $R_{GK}$  = 1  $k\Omega$ ; Fig. 12. Critical rate of rise of off-state voltage as a function of junction temperature; typical values

# 11. Package outline





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### 12. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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